2.5V Drive Pch MOS FET

RTR020P02

●Structure

Silicon P-channel MOS FET

● Features

- 1) Low On-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (TSMT3).

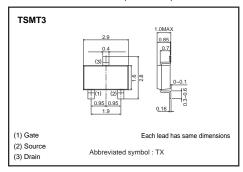
Application

Power switching, DC / DC converter.

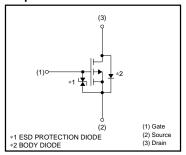
Packaging specifications

	Package	Taping
Туре	Code	TL
	Basic ordering unit (pieces)	3000
RTR020P02		0

●External dimensions (Unit:mm)



●Equivalent circuit



●Absolute maximum ratings (Ta=25°C)

Parameter		Symbol	Limits	Unit				
Drain-source voltage		VDSS	-20	V				
Gate-source voltage		V _{GSS}	±12	V				
Drain current	Continuous	ID	±2.0	Α				
	Pulsed	I _{DP} *1	±8.0	А				
Source current (Body diode)	Continuous	Is	-0.8	Α				
	Pulsed	Isp *1	-3.2	A				
Total power dissipation		P _D *2	1.0	W				
Channel temperature		Tch	150	°C				
Range of Storage temperature		Tstg	-55 to +150	°C				

^{*1} Pw≤10μs, Duty cycle≤1% *2 Mounted on a ceramic board

●Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth (ch-a)*	125	°C/W

^{*} Mounted on a ceramic board.

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	-	±10	μΑ	V _{GS} =±12V, V _{DS} =0V
Drain-source breakdown voltage	V _{(BR) DSS}	-20	-	-	V	I _D = -1mA, V _{GS} =0V
Zero gate voltage drain current	IDSS	-	-	-1	μΑ	V _{DS} = -20V, V _{GS} =0V
Gate threshold voltage	V _{GS (th)}	-0.7	-	-2.0	V	V _{DS} = -10V, I _D = -1mA
Static drain-source on-state resistance		-	100	135	mΩ	I _D = -2.0A, V _G S= -4.5V
	RDS (on)*	_	110	150	mΩ	Ip= -2.0A, Vgs= -4.0V
		-	180	250	mΩ	I _D = -1.0A, V _G S= -2.5V
Forward transfer admittance	Y _{fs} *	1.2	-	_	S	V _{DS} = -10V, I _D = -1.0A
Input capacitance	Ciss	-	430	-	pF	V _{DS} = -10V
Output capacitance	Coss	-	80	_	pF	V _G s=0V
Reverse transfer capacitance	Crss	-	55	_	pF	f=1MHz
Turn-on delay time	t _{d (on)} *	-	11	_	ns	ID= -1.0A
Rise time	tr *	-	13	-	ns	VDD≒ -15V
Turn-off delay time	t _{d (off)} *	-	38	_	ns	V _{GS} = -4.5V R _L =15Ω
Fall time	t _f *	-	12	_	ns	R _G =10Ω
Total gate charge	Qg	_	4.9	-	nC	V _{DD} ≒-15V
Gate-source charge	Qgs	-	1.2	-	nC	Vgs=-4.5V
Gate-drain charge	Q _{gd}	_	1.3	_	nC	I _D = -2.0A

^{*}Pulsed

●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Forward voltage	V _{SD}	_	_	-1.2	V	I _S = -0.8A, V _{GS} =0V

Electrical characteristic curves

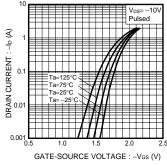


Fig.1 Typical Transfer Characteristics

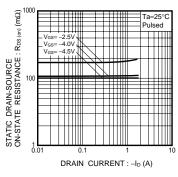


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current

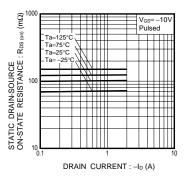


Fig.3 Static Drain-Source On-State Resistance vs. Drain Current

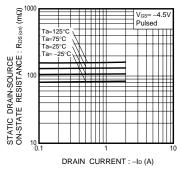


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

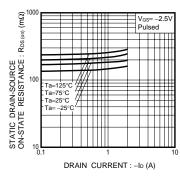


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

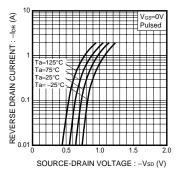


Fig.6 Reverse Drain Current vs.Source-Drain Voltage

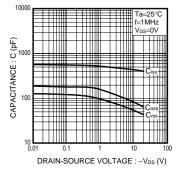


Fig.7 Typical Capacitance vs. Drain-Source Voltage

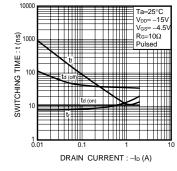


Fig.8 Switching Characteristics

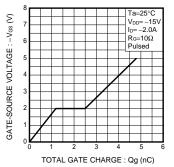


Fig.9 Dynamic Input Characteristics

●Measurement circuits

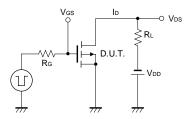


Fig.10 Switching Time Test Circuit

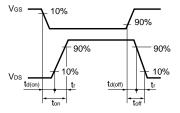


Fig.11 Switching Time Waveforms

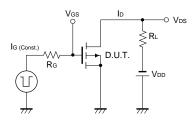


Fig.12 Gate Charge Test Circuit

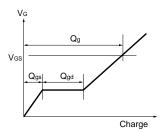


Fig.13 Gate Charge Waveform

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